

NPN 6 GHz wideband transistor

BFR93A

FEATURES

- High power gain
- Low noise figure
- Very low intermodulation distortion.

APPLICATIONS

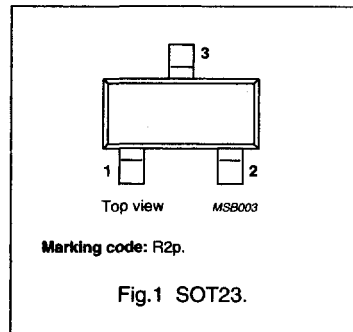
- RF wideband amplifiers and oscillators.

DESCRIPTION

NPN wideband transistor in a plastic SOT23 package.
PNP complement: BFT93.

PINNING

PIN	DESCRIPTION
1	base
2	emitter
3	collector



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	-	15	V
V_{CEO}	collector-emitter voltage	open base	-	12	V
I_C	collector current (DC)		-	35	mA
P_{tot}	total power dissipation	$T_s \leq 95^\circ\text{C}$	-	300	mW
C_{re}	feedback capacitance	$I_C = 0$; $V_{CE} = 5\text{ V}$; $f = 1\text{ MHz}$	0.6	-	pF
f_T	transition frequency	$I_C = 30\text{ mA}$; $V_{CE} = 5\text{ V}$; $f = 500\text{ MHz}$	6	-	GHz
G_{UM}	maximum unilateral power gain	$I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 1\text{ GHz}$; $T_{amb} = 25^\circ\text{C}$	13	-	dB
		$I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 2\text{ GHz}$; $T_{amb} = 25^\circ\text{C}$	7	-	dB
F	noise figure	$I_C = 5\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 1\text{ GHz}$; $T_s = \Gamma_{opt}$; $T_{amb} = 25^\circ\text{C}$	1.9	-	dB
V_O	output voltage	$d_{im} = -60\text{ dB}$; $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $R_L = 75\ \Omega$; $T_{amb} = 25^\circ\text{C}$; $f_p + f_q - f_r = 793.25\text{ MHz}$	425	-	mV

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	-	15	V
V_{CEO}	collector-emitter voltage	open base	-	12	V
V_{EBO}	emitter-base voltage	open collector	-	2	V
I_C	collector current (DC)		-	35	mA
P_{tot}	total power dissipation	$T_s \leq 95^\circ\text{C}$; note 1	-	300	mW
T_{stg}	storage temperature		-65	+150	$^\circ\text{C}$
T_j	junction temperature		-	+175	$^\circ\text{C}$

Note

1. T_s is the temperature at the soldering point of the collector pin.

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-s}$	thermal resistance from junction to soldering point	$T_s \leq 95\text{ °C}$; note 1	260	K/W

Note

- T_s is the temperature at the soldering point of the collector pin.

CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise specified.

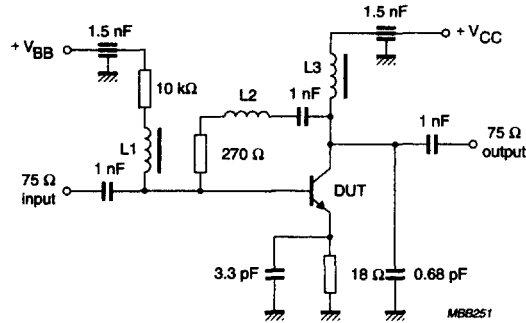
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CBO}	collector cut-off current	$I_E = 0$; $V_{CB} = 5\text{ V}$	–	–	50	nA
h_{FE}	DC current gain	$I_C = 30\text{ mA}$; $V_{CE} = 5\text{ V}$	40	90	–	
C_c	collector capacitance	$I_E = I_B = 0$; $V_{CB} = 5\text{ V}$; $f = 1\text{ MHz}$	–	0.7	–	pF
C_e	emitter capacitance	$I_C = I_C = 0$; $V_{EB} = 0.5\text{ V}$; $f = 1\text{ MHz}$	–	1.9	–	pF
C_{re}	feedback capacitance	$I_C = I_C = 0$; $V_{CE} = 5\text{ V}$; $f = 1\text{ MHz}$; $T_{amb} = 25\text{ °C}$	–	0.6	–	pF
f_T	transition frequency	$I_C = 30\text{ mA}$; $V_{CE} = 5\text{ V}$; $f = 500\text{ MHz}$	4.5	6	–	GHz
G_{UM}	maximum unilateral power gain (note 1)	$I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 1\text{ GHz}$; $T_{amb} = 25\text{ °C}$	–	13	–	dB
		$I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 2\text{ GHz}$; $T_{amb} = 25\text{ °C}$	–	7	–	dB
F	noise figure (note 2)	$I_C = 5\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 1\text{ GHz}$; $\Gamma_s = \Gamma_{opt}$; $T_{amb} = 25\text{ °C}$	–	1.9	–	dB
		$I_C = 5\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 2\text{ GHz}$; $\Gamma_s = \Gamma_{opt}$; $T_{amb} = 25\text{ °C}$	–	3	–	dB
V_O	output voltage	notes 2 and 3	–	425	–	mV
d_2	second order intermodulation distortion	notes 2 and 4	–	–50	–	dB

Notes

- G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and $G_{UM} = 10 \log \frac{|S_{21}|^2}{(1 - |S_{11}|^2)(1 - |S_{22}|^2)}$ dB.
- Measured on the same die in a SOT37 package (BFR91A).
- $d_{im} = -60\text{ dB}$ (DIN 45004B); $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $R_L = 75\ \Omega$; $T_{amb} = 25\text{ °C}$;
 $V_p = V_O$ at $d_{im} = -60\text{ dB}$; $f_p = 795.25\text{ MHz}$;
 $V_q = V_O - 6\text{ dB}$ at $f_q = 803.25\text{ MHz}$;
 $V_r = V_O - 6\text{ dB}$ at $f_r = 805.25\text{ MHz}$;
 measured at $f_p + f_q - f_r = 793.25\text{ MHz}$.
- $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $R_L = 75\ \Omega$; $T_{amb} = 25\text{ °C}$;
 $V_p = 200\text{ mV}$ at $f_p = 250\text{ MHz}$;
 $V_q = 200\text{ mV}$ at $f_q = 560\text{ MHz}$;
 measured at $f_p + f_q = 810\text{ MHz}$.

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L1 = L3 = 5 μH choke.
 L2 = 3 turns 0.4 mm copper wire; winding pitch 1 mm; internal diameter 3 mm.

Fig.2 Intermodulation distortion and second harmonic distortion MATV test circuit.

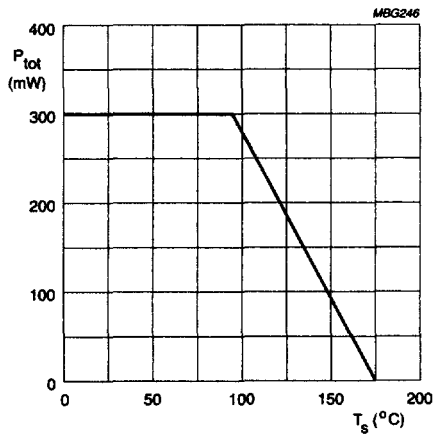
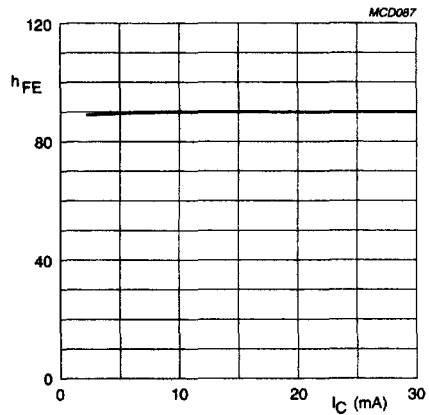


Fig.3 Power derating curve.

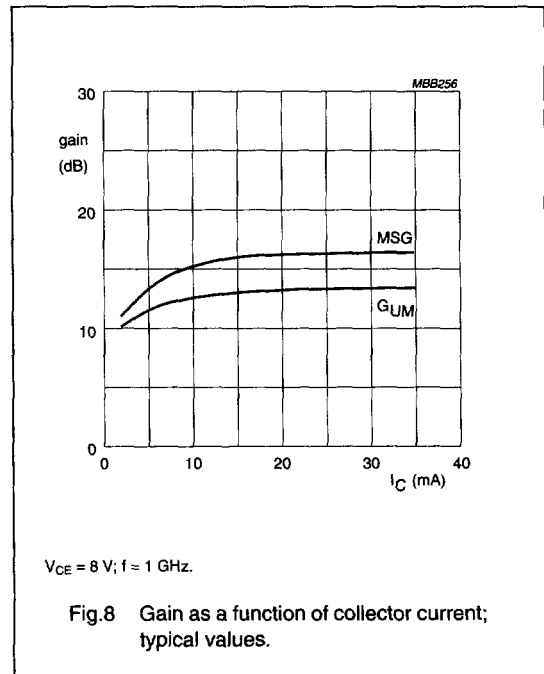
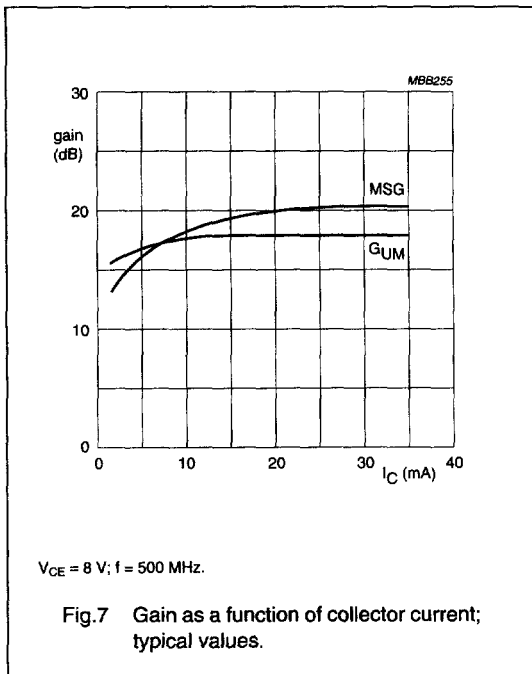
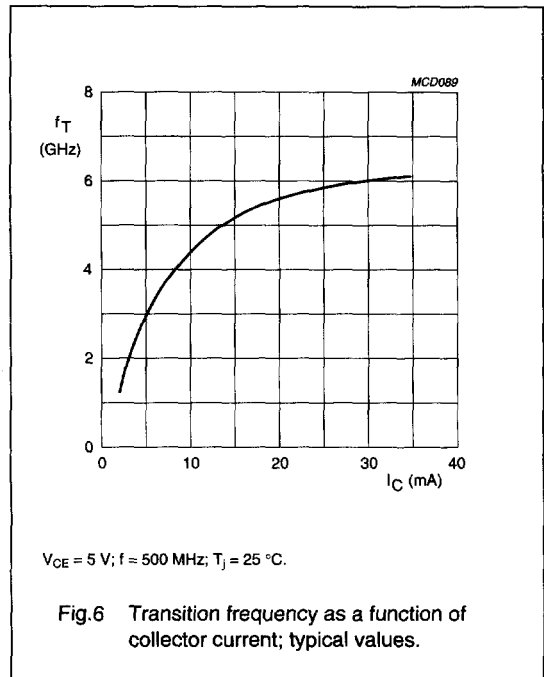
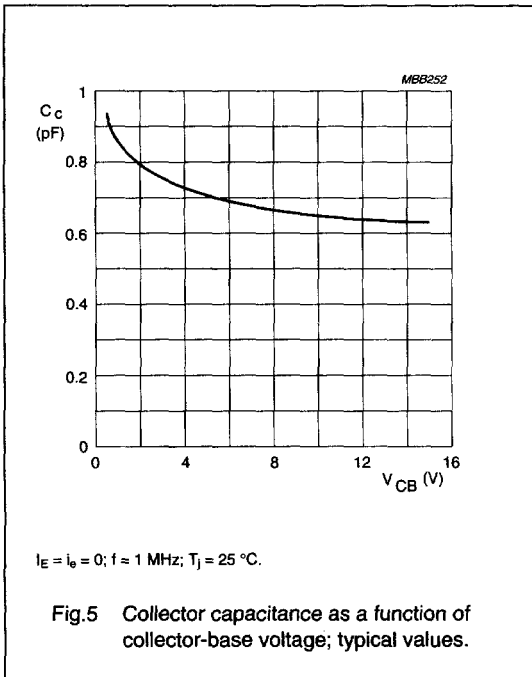


$V_{CE} = 5 \text{ V}; T_J = 25 \text{ }^\circ\text{C}.$

Fig.4 DC current gain as a function of collector current.

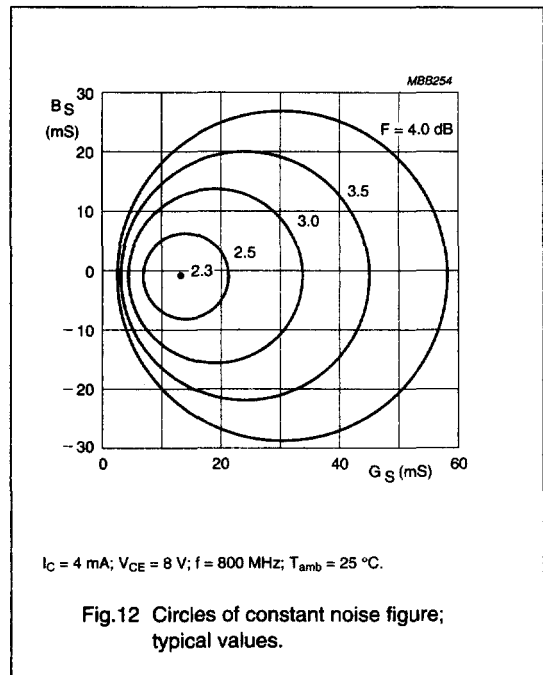
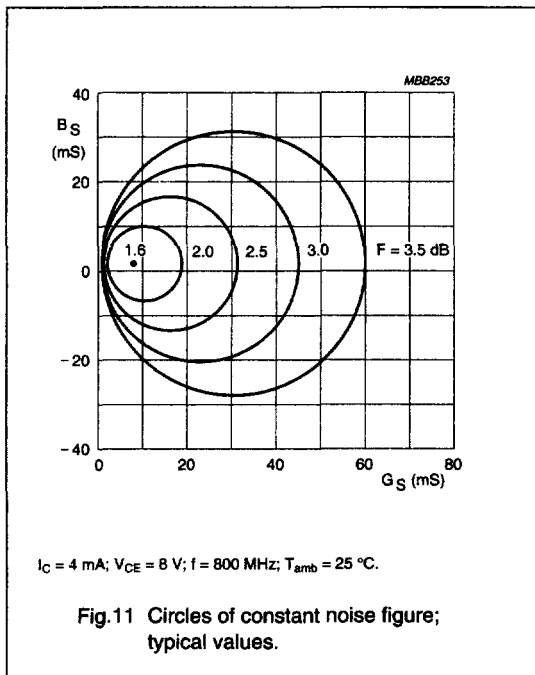
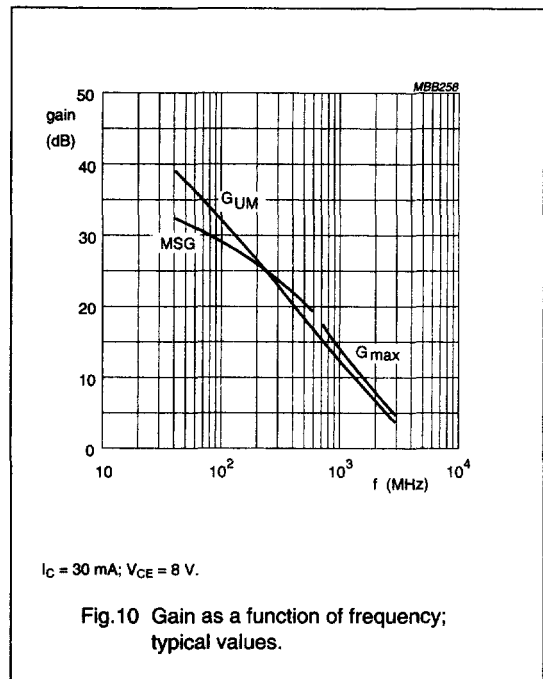
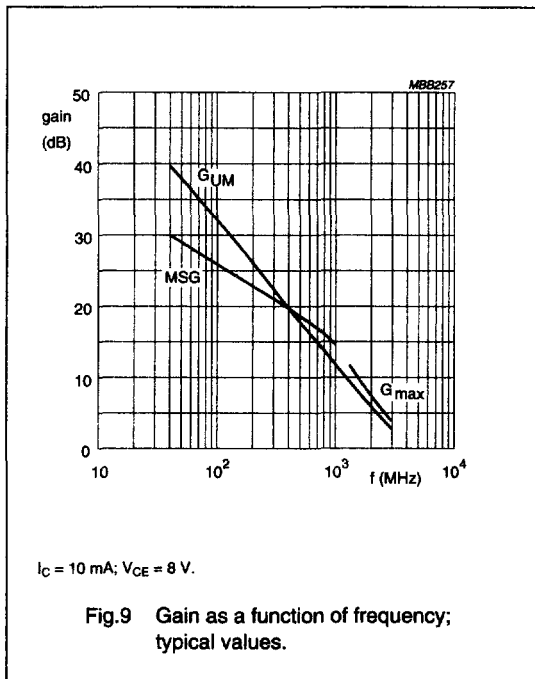
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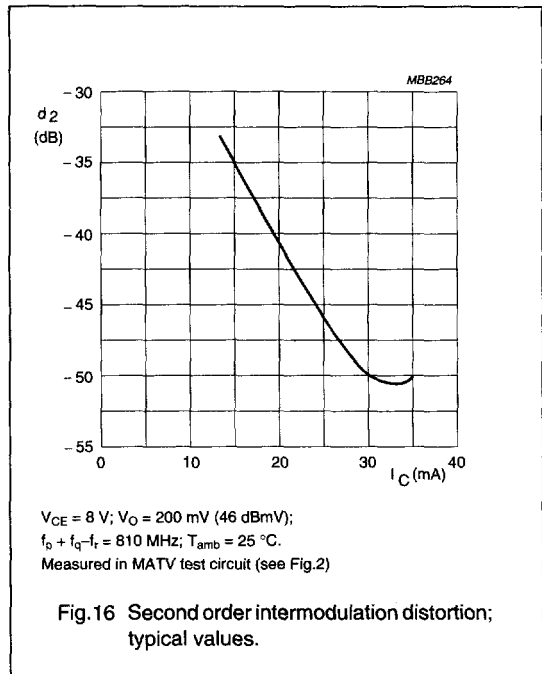
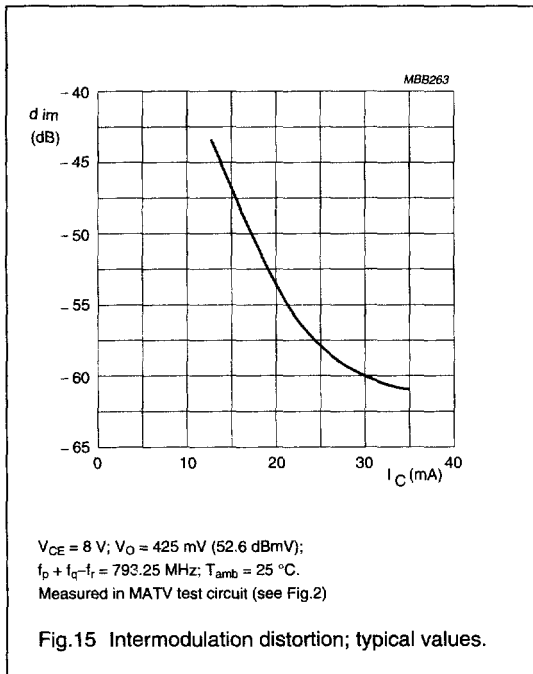
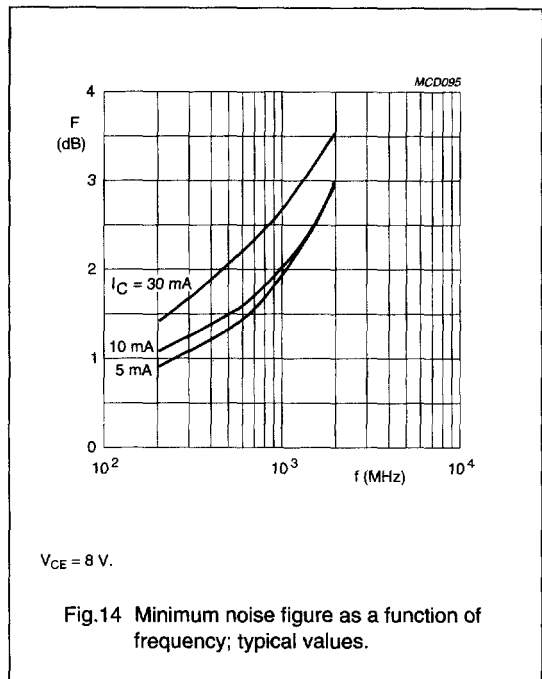
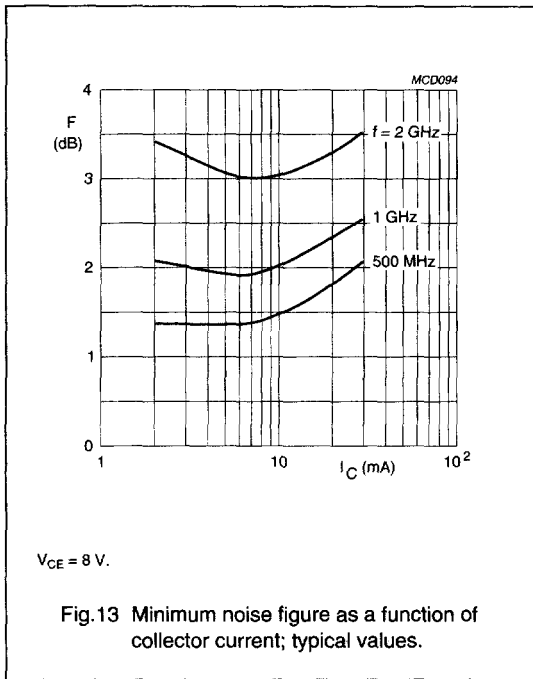
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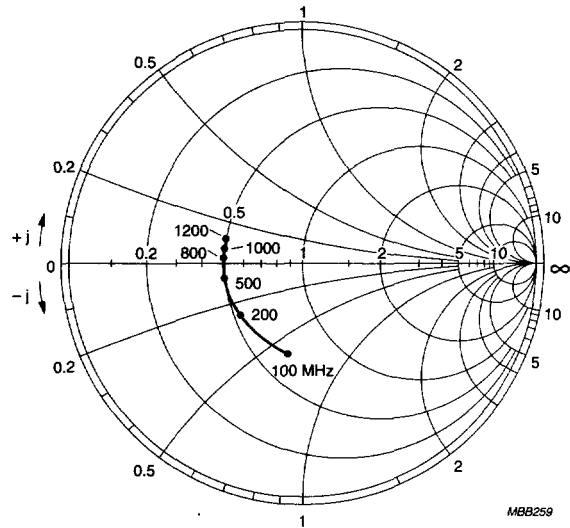
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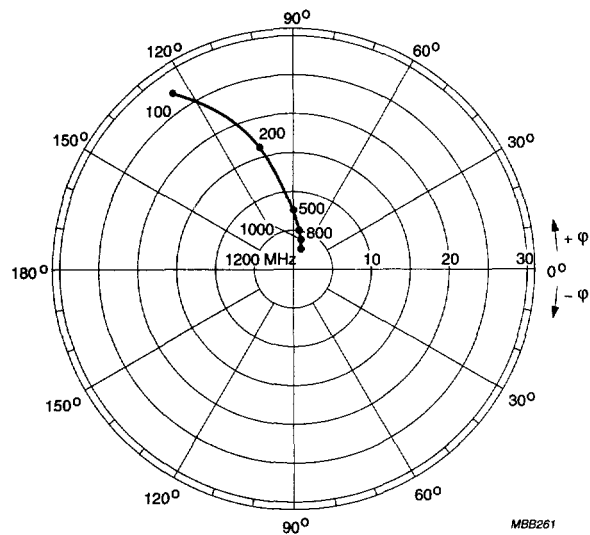
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$I_C = 30 \text{ mA}$; $V_{CE} = 8 \text{ V}$; $Z_o = 50 \Omega$; $T_{amb} = 25 \text{ }^\circ\text{C}$.

Fig.17 Common emitter input reflection coefficient (S_{11}).



$I_C = 30 \text{ mA}$; $V_{CE} = 8 \text{ V}$; $T_{amb} = 25 \text{ }^\circ\text{C}$.

Fig.18 Common emitter forward transmission coefficient (S_{21}).

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